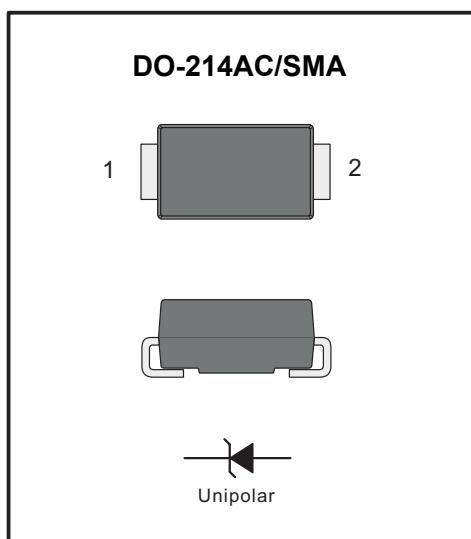


## SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



### Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction,majority carrier conduction
- ◆ Low power loss,high efficiency
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:  
250 °C/10 seconds at terminals

### Mechanical Data

- ◆ Case': JEDEC DO-214AC/SMA molded plastic body
- ◆ Terminals': Solderable per MIL-STD-750,Method 2026
- ◆ Polarity': Color band denotes cathode end Mounting
- ◆ Position': Any
- ◆ Weight : 0.0018 ounce, 0.064 grams

### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

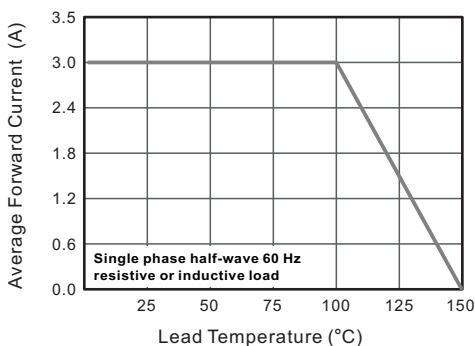
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	SYMBOLS	SS32	SS33	SS34	SS35	SS36	SS38	SS310	SS3150	SS3200	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	30	40	50	60	80	100	150	200	V
Maximum RMS voltage	$V_{RMS}$	14	21	28	35	42	56	70	105	140	V
Maximum DC blocking voltage	$V_{DC}$	20	30	40	50	60	80	100	150	200	V
Maximum average forward rectified current at TL(see fig.1)	$I_{(AV)}$							3.0			A
Peak forward surge current 8.3ms single half sine-wave superimposed onrated load (JEDEC Method)	$I_{FSM}$							100			A
Maximum instantaneous forward voltage at 3.0A	$V_F$		0.55		0.70		0.85		0.95		V
Maximum DC reverse current $T_A=25^\circ C$ at rated DCblocking voltage $T_A=125^\circ C$	$I_R$			0.5			0.2		2.0		mA
				20			10				
Typical junction capacitance (NOTE 1)	$C_J$	500			300						pF
Typical thermal resistance (NOTE 2)	$R_{\theta JA}$			55.0							°C/W
Operating junction temperature range	$T_J$		-55 to +125				-55 to +150				°C
Storage temperature range	$T_{STG}$				-55 to +150						°C

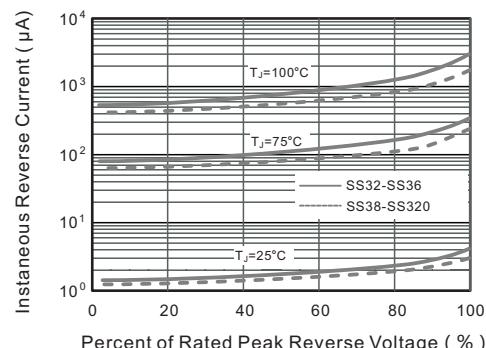
Note:1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2.P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas

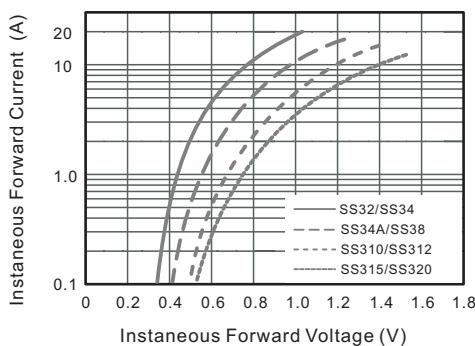
**Fig.1 Forward Current Derating Curve**



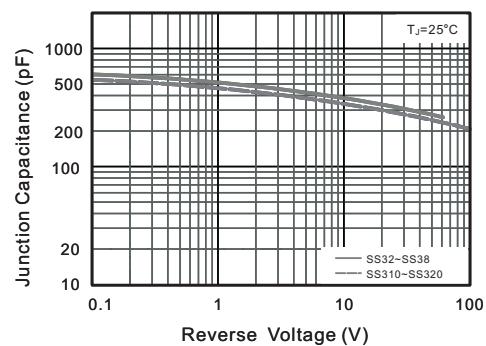
**Fig.2 Typical Reverse Characteristics**



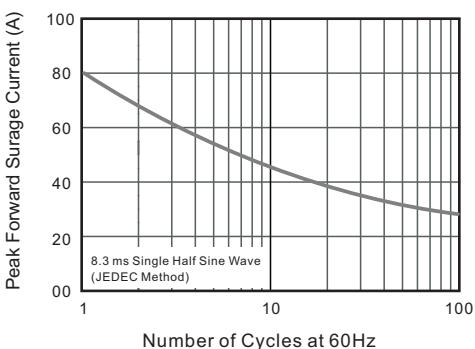
**Fig.3 Typical Forward Characteristic**



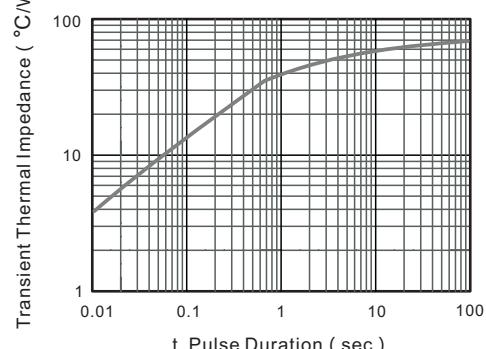
**Fig.4 Typical Junction Capacitance**



**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



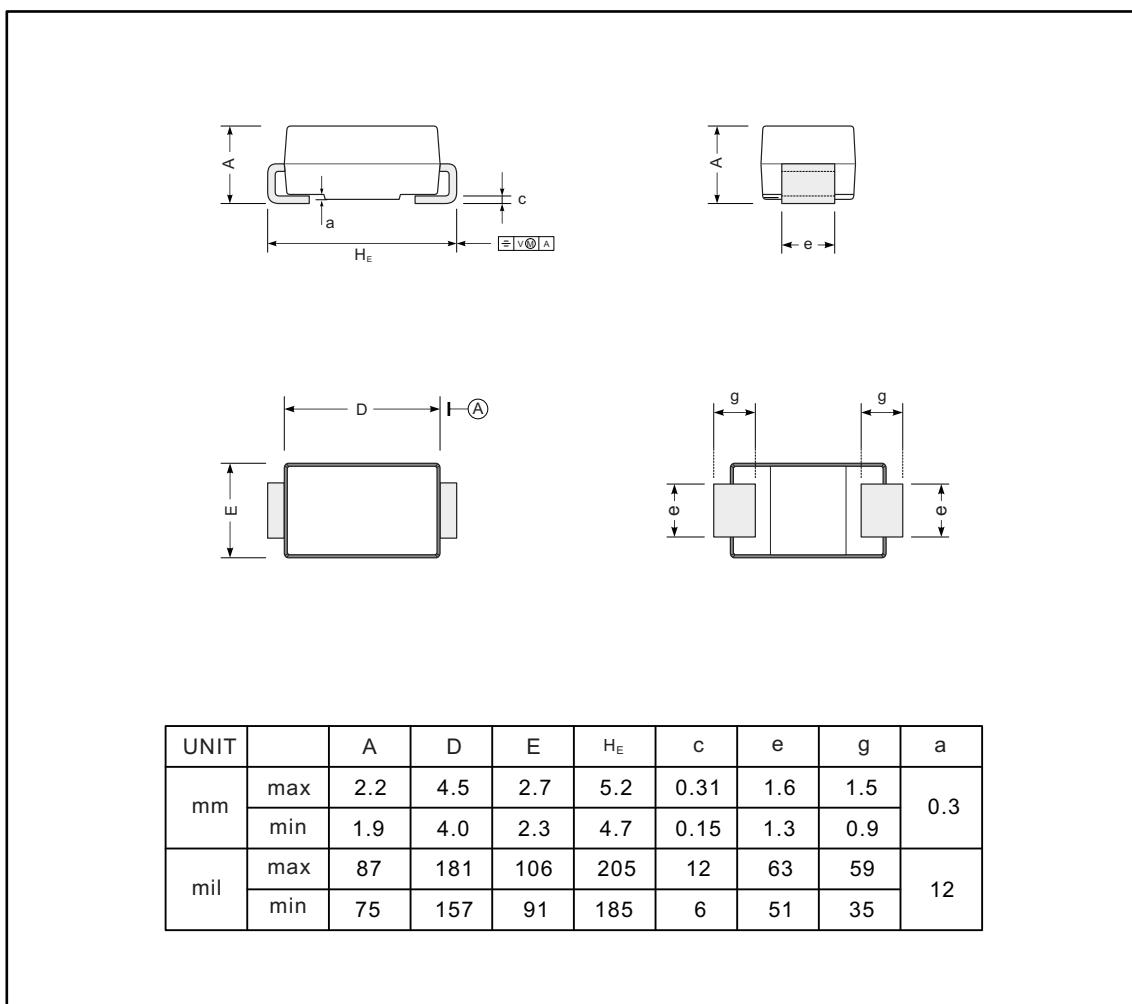
**Fig.5- Typical Transient Thermal Impedance**



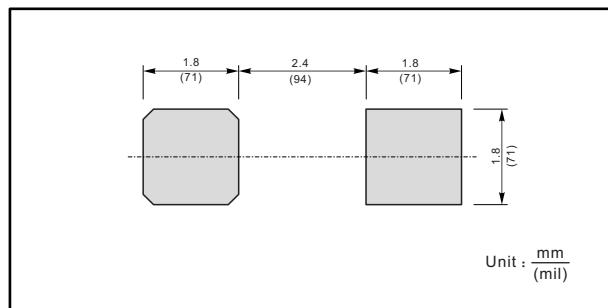
## PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMA



The recommended mounting pad size



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